

## 16-Channel LED Driver for Local Dimming

### 1 Description

The AS3812 is the next generation of fully integrated 16-channel LED backlight driver. LED current set resistors are integrated in order to save external components as well as reducing the pin-count of the IC while maintaining a very high absolute LED current accuracy of  $\pm 1\%$ .

The speed of the current regulation has been increased to support minimum PWM on times down to  $1\mu\text{s}$ . 12-bit fully flexible PWM generators per channel and 10-bit LED current resolution can be used to adjust the brightness of the LED strings.

Dialog's patented digital enhanced DC/DC feedback function is regulating any external SMPS to the best suitable output voltage needs of the LED strings to minimize power dissipation.

Dialog's patented dimming method allows synchronizing the PWM generators with V/HSYNC of the video SOC/GPU.

The device can be programmed via SPI and daisy chain connection to cascade many devices easily.

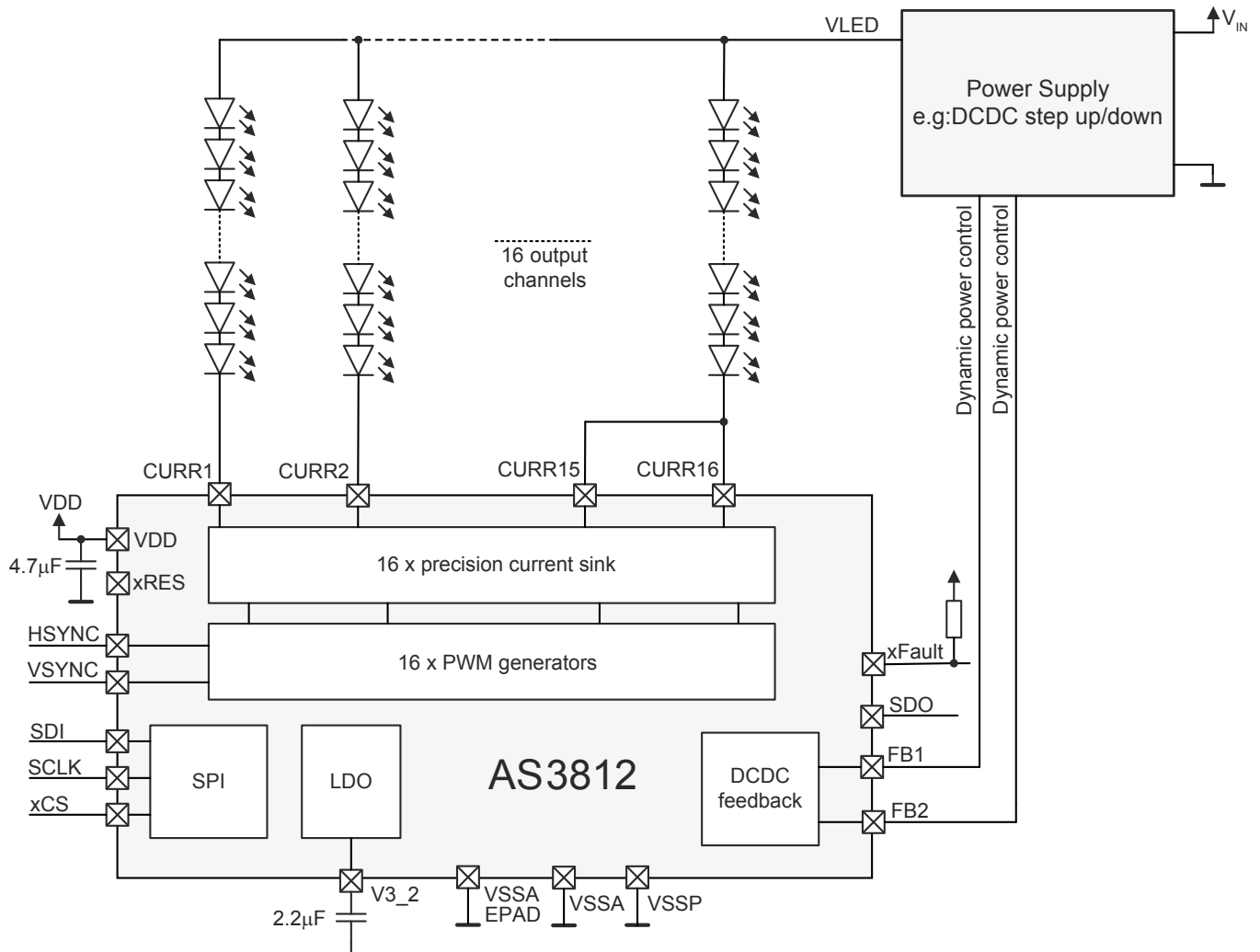
### 2 Features

- 16 fully flexible, 12-bit PWM generators provide optimum power savings through local dimming
  - » Period, high time, delay, reverse functions
- Global 10-bit IDAC gives  $\pm 1\%$  LED current accuracy for highest brightness uniformity
- Integrated current sink FETs and current set resistors – Lower BOM cost
- VSYNC and HSYNC inputs and integrated digital PLL allow synchronization with TV frame
- Universally compatible DC/DC feedback architecture with digital enhancement – configurable via SPI
- Fully protected with integrated features
  - » Short/Open LED detection
  - » Over-temperature shutdown
  - » Register lock/unlock
- Minimum PWM on-time of  $1\mu\text{s}$  – enables high contrast ratios

### 3 Applications

- Ultra-HD/4K TVs
- LCD Monitors
- Notebooks/medium-small size displays

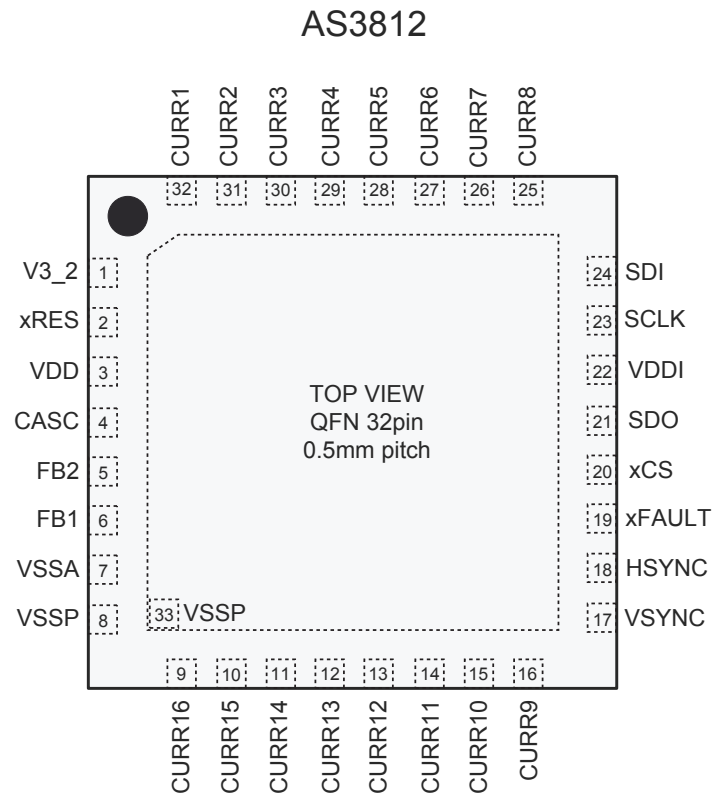
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**Figure 3.1 : AS3812 Typical Application**  
 (With CURR15 and CURR16 connected together to show increased LED string current capability by paralleling outputs)

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### 4 Pinout Description



**Figure 4.1 : Pin Diagram of AS3812 (Top View)**

Pin Number	Pin Name	Type	Pin Description	If Not Used
1	V3_2	P	Output of 3.2V LDO Connect 2.2 $\mu$ F capacitor to GND	
2	xRES	DI	Reset input active low Connect pull up resistor to VDDI	
3	VDD	P	Supply Voltage input Connect 4.7 $\mu$ F bypass capacitor to GND	
4	CASC	A_I/O	Connect to external cascade circuit	Leave open
5	FB2	A_I/O	Power supply feedback Connect to external SMPS	Leave open
6	FB1	A_I/O	Power supply feedback Connect to external SMPS	Leave open
7	VSSA	P	GND	
8	VSSP	P	GND	
9	CURR16	A_I/O	LED current output	Leave open
10	CURR15	A_I/O	LED current output	Leave open

## 16-Channel LED Driver for Local Dimming

### 4 Pinout Description (cont'd)

Pin Number	Pin Name	Type	Pin Description	If Not Used
11	CURR14	A_I/O	LED current output	Leave open
12	CURR13	A_I/O	LED current output	Leave open
13	CURR12	A_I/O	LED current output	Leave open
14	CURR11	A_I/O	LED current output	Leave open
15	CURR10	A_I/O	LED current output	Leave open
16	CURR9	A_I/O	LED current output	Leave open
17	VSYNC	DI-PD	Vertical sync frequency, PWM generator start/reset, DPLL input	Leave open
18	HSYNC	DI-PD	External clock input	Leave open
19	xFault	DO-OD	Fault output (interrupt, active low) Connect pull up resistor to VDDI	Leave open
20	xCS	DI-PU	SPI interface chip select (active low)	Leave open
21	SDO	DO	SPI interface data output Daisy Chain: Connect to SDI of next device	Leave open
22	VDDI	P	Power Supply of digital input/output cells	Leave open
23	SCLK	DI-PD	SPI interface clock	Leave open
24	SDI	DI-PD	SPI interface data input	Leave open
25	CURR8	A_I/O	LED current output	Leave open
26	CURR7	A_I/O	LED current output	Leave open
27	CURR6	A_I/O	LED current output	Leave open
28	CURR5	A_I/O	LED current output	Leave open
29	CURR4	A_I/O	LED current output	Leave open
30	CURR3	A_I/O	LED current output	Leave open
31	CURR2	A_I/O	LED current output	Leave open
32	CURR1	A_I/O	LED current output	Leave open
33	EP	P	Exposed Pad: Connect to GND	

**A\_I/O:** Analog pin

**P:** Power pin

**DO:** Digital Output

**DO\_OD:** Digital Output Open Drain

**DI:** Digital Input

**DI\_PU:** Digital Input with Pull Up resistor

**DI\_PD:** Digital Input with Pull Down resistor

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### 5 Absolute Maximum Ratings

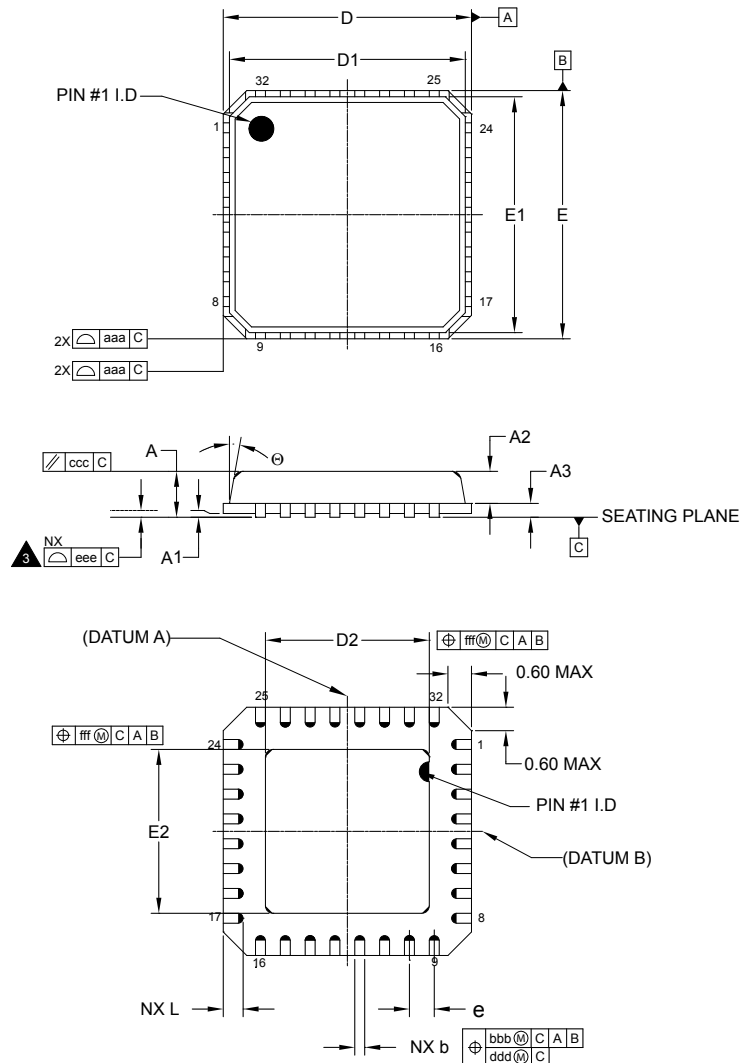
Absolute maximum ratings are the parameter values or ranges which can cause permanent damage if exceeded. For maximum safe operating conditions, refer to the Electrical Characteristics section.

Parameter	Symbol	Comments	Min	Max	Unit
Electrical Parameters					
Supply Voltage to Ground	V <sub>DDMAX</sub> / V <sub>GND</sub>	Applicable for pin VDD	-0.3	7	V
Maximum Voltage	V <sub>IN_5V</sub>	Applicable for pins: FB1, FB2, VSYNC,HSYNC, V3_2, SDI, SDO, SCLK, xCS, xFAULT, xRES, VDDI	-0.3	VDD+0.3	V
Maximum voltage CURRx pins	V <sub>IN_30V</sub>	Applicable for pins: CURR1-CURR16	-0.3	30	V
Input Current (latch-up immunity)	I <sub>SCR</sub>	JEDEC JESD78D Nov 2011	±100		mA
Electrostatic Discharge					
Electrostatic Discharge on all 5V pins - HBM	ESD <sub>HBM_LV</sub>	JS-001-2012	±2000		V
Electrostatic Discharge on all HV pins - HBM	ESD <sub>HBM_HV</sub>	JS-001-2012	±8000		V
Electrostatic Discharge CDM	ESD <sub>CDM</sub>	JEDEC JESD22-C101F Oct 2013	±500		V
Electrostatic Discharge MM	ESD <sub>MM</sub>	JESD22-A115C	±100		V
Temperature Ranges and Storage Conditions					
Junction to Ambient Thermal Resistance	R <sub>THJA</sub>	R <sub>THJA</sub> typical 35°C/W			°C/W
Operating Junction Temperature	T <sub>J</sub>		-20	115	°C
Storage Temperature Range	T <sub>STRG</sub>		-55	150	°C
Package Body Temperature	T <sub>BODY</sub>	IPC/JEDEC J-STD-020 The reflow peak soldering temperature (body temperature) is specified according to IPC/JEDEC J-STD-020 “Moisture/Reflow Sensitivity Classification for Non-hermetic Solid State Surface Mount Devices.” The lead finish for Pb-free leaded packages is “Matte Tin” (100% Sn)		260	°C
Relative Humidity (non-condensing)	RH <sub>NC</sub>		5	85	%
Moisture Sensitivity Level	MSL	Maximum floor life time of 168h	3		

**Note 1.** Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, so functional operation of the device at these or any other conditions beyond those indicated in the Electrical Characteristics of the specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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### 6 Physical Dimensions



REF.	MIN	NOM	MAX
A	0.80	0.90	1.00
A1	0	0.02	0.05
A2	-	0.65	1.00
A3	-	0.20 REF	-
L	0.35	0.40	0.45
$\theta$	0°	-	14°
b	0.18	0.25	0.30
D	-	5.00 BSC	-
E	-	5.00 BSC	-
e	-	0.50 BSC	-
D2	3.40	3.50	3.60
E2	3.40	3.50	3.60
D1	-	4.75 BSC	-
E1	-	4.75 BSC	-
aaa	-	0.15	-
bbb	-	0.10	-
ccc	-	0.10	-
ddd	-	0.05	-
eee	-	0.08	-
fff	-	0.10	-
N	-	32	-

#### NOTE:

1. DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5M-1994.
2. ALL DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES)
3. COPLANARITY APPLIES TO THE EXPOSED HEAT SLUG AS WELL AS THE TERMINAL.
4. RADIUS ON TERMINAL IS OPTIONAL.
5. N IS THE TOTAL NUMBER OF TERMINALS.

Figure 6.1 : QFN-32 package outline drawing

## 16-Channel LED Driver for Local Dimming

### 7 Ordering Information

Part Number	Ordering Code	Options	Package	Description
AS3812A	AS3812A-ZQFT	16-Channel Version	32-Pin QFN	Tape & Reel <sup>1</sup>

**Note 1.** Tape & Reel packing quantity is 4,000/reel. Minimum packing quantity is 4,000.

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